

Features

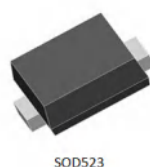
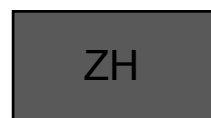
180 W(8x20us) Peak Pulse Power
Low Clamping Voltage
SOD-523 Package
RoHS Compliant
Matte Tin Lead finish (Pb-Free)
Protect One I/O or Power Line
Meet IEC61000-4-2 Level 4:
Contact Discharge > 30 kV
Air Discharge > 30 kV

Mechanical Data

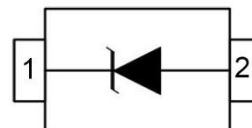
SOD523 package
Molding compound flammability rating: UL 94V-0
Packaging: Tape and Reel
RoHS/WEEE Compliant

Applications

Smart Phones
Laptop Computers
Portable Electronics



SOD523



SOD-523

Schematic & PIN Configuration

Absolute Maximum Rating

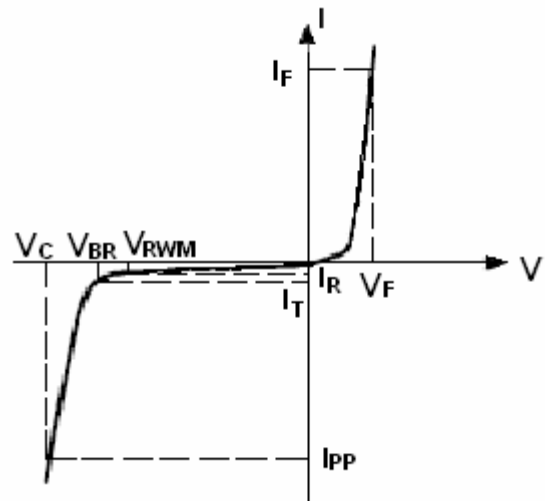
Symbol	Parameter	Value	Unit
TJ	Junction Temperature	-55 to +150	°C
TSTG	Storage Temperature	-55 to +150	°C
Ipp Max	Maximum Peak Pulse Current	10	A
PPK	Peak Pulse Power	180	W

Electrical Characteristics

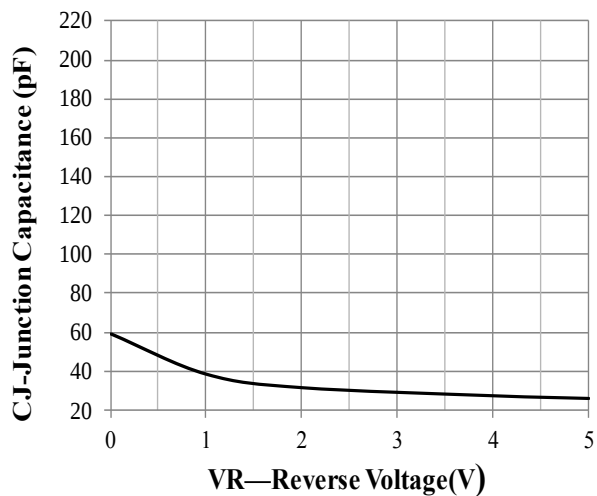
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
VRWM	Reverse Working Peak Voltage				7.0	V
VBR	Reverse Breakdown Voltage	$I_T = 1\text{mA}$	7.5	8.5	10	V
IR	Reverse Leakage Current	$VRWM = 7.0\text{V}$			1	μA
VC	Clamping Voltage	$I_{PP} = 1\text{A} (8/20\mu\text{s})$		9.8		V
VC	Clamping Voltage	$I_{PP} = 10\text{A} (8/20\mu\text{s})$		13	18	V
Ipp	Peak Pulse Current	$t_p = 8/20\mu\text{s}$			10	A
CJ	Capacitance	$VR = 0\text{V}, f = 1\text{MHz}$		60	85	pF

Electrical Parameter

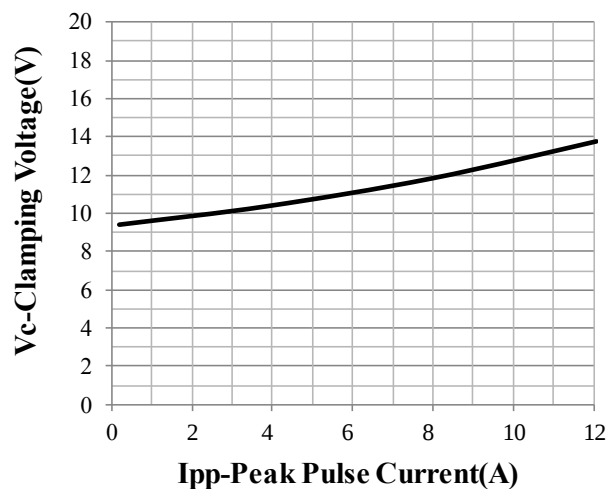
Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
I_T	Test Current
V_{BR}	Breakdown Voltage @ I_T
I_F	Forward Current
V_F	Forward Voltage @ I_F



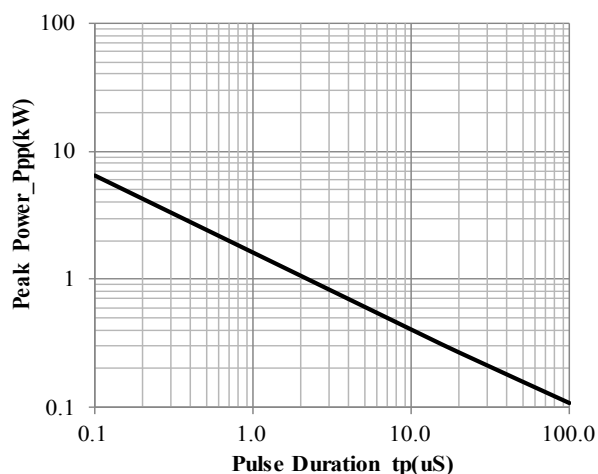
RATING AND CHARACTERISTIC CURVES



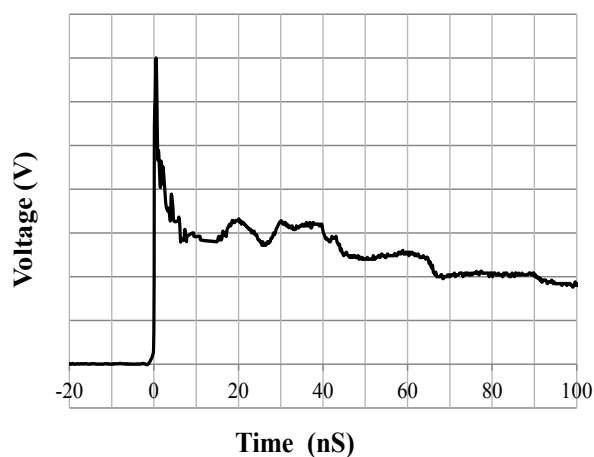
Junction Capacitance vs. Reverse Voltage



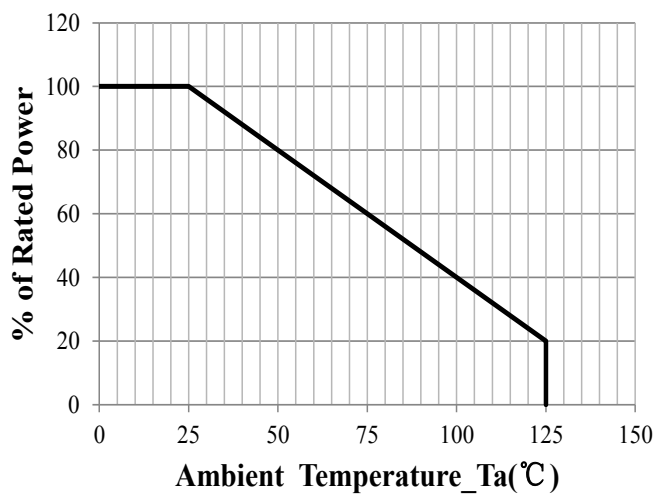
Clamping Voltage vs. Peak Pulse Current



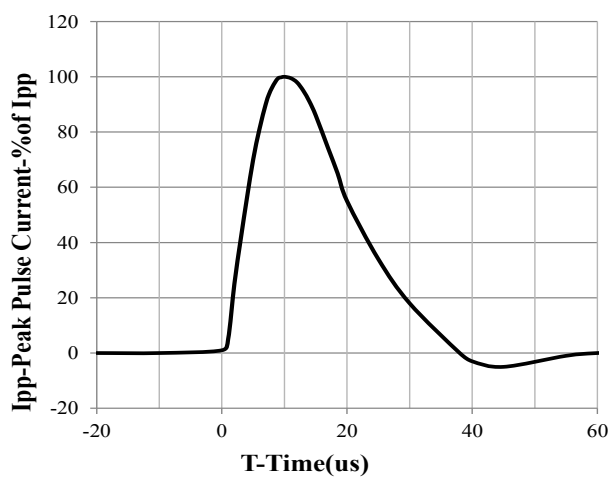
Peak Pulse Power vs. Pulse Time



IEC61000-4-2 Pulse Waveform



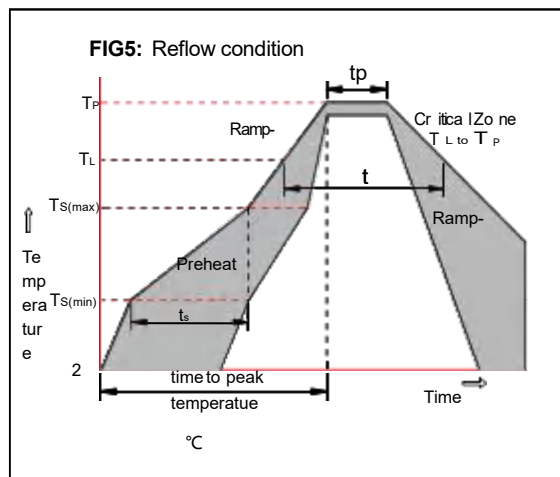
Power Derating Curve



8 X 20us Pulse Waveform

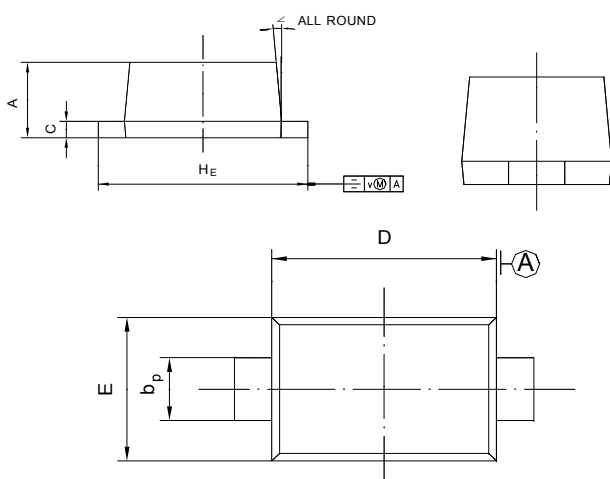
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

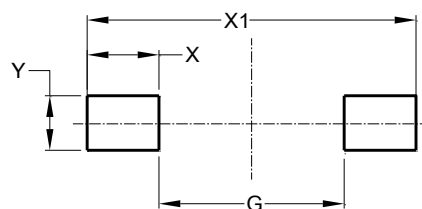


Package Dimensions & Suggested Pad Layout

SOD523



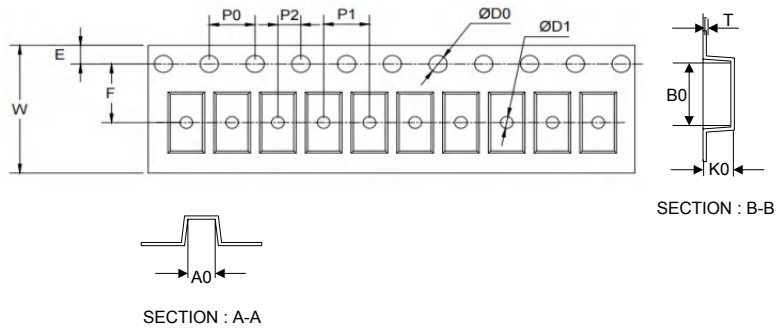
UNIT	A	b _p	C	D	E	H _E	V	∠
mm	0.70 0.50	0.40 0.20	0.14 0.05	1.30 1.10	0.90 0.75	1.70 1.50	0.1	5°



Dimensions	Value (in mm)
G	0.85
X	0.70
X1	2.25
Y	0.80

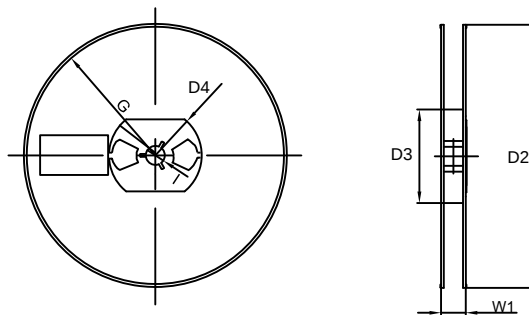
Tape & reel specification

Tape



Symbol	Dimension (mm)
P0	4.00±0.20
P1	2.00±0.20
P2	2.00±0.20
D0	1.55±0.20
D1	0.50±0.20
E	1.55±0.25
F	3.60±0.20
W	8.00±0.20
A0	1.30±0.20
B0	2.35±0.20
K0	0.95±0.20
T	0.20±0.20
D2	177.0±5.0
D3	55Min.
D4	R24.6±2.0
G	R82.0±2.0
I	13.0±2.0
W1	10.20±3.0

7" Reel



Quantity: 3000PCS